SDAS053B - APRIL 1982 - REVISED JANUARY 1995

- 'AS1034A Offer High Capacitive-Drive Capability
- Noninverting Drivers
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

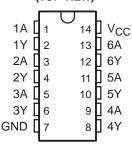
These devices contain six independent noninverting drivers. They perform the Boolean function Y = A.

The SN54ALS1034 and SN54AS1034A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS1034 and SN74AS1034A are characterized for operation from 0°C to 70°C.

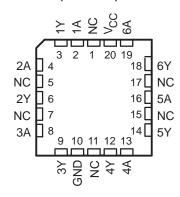
FUNCTION TABLE (each buffer)

INPUT A	OUTPUT Y
Н	Н
L	L

SN54ALS1034, SN54AS1034A . . . J PACKAGE SN74ALS1034, SN74AS1034A . . . D OR N PACKAGE (TOP VIEW)



SN54ALS1034, SN54AS1034A . . . FK PACKAGE (TOP VIEW)



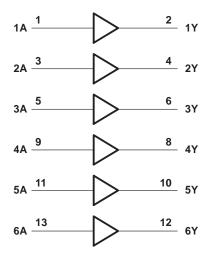
NC - No internal connection

logic symbol†

1 1	1	D	2	1Y
1A	3		4	2Y
2A 3A	5		6	3Y
	9		8	
4A	11		10	4Y
5A	13		12	5Y
6A				6Y

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

SN54ALS1034, SN54AS1034A, SN74ALS1034, SN74AS1034A HEX DRIVERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}		 7 V
Input voltage, V _I		 7 V
Operating free-air temperature range, T _A :		
	SN74ALS1034	 0°C to 70°C
Storage temperature range		 65°C to 150°C

recommended operating conditions

		SN	54ALS10	34	SN	74ALS10	34	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			8.0	V
IOH	High-level output current			-12			-15	mA
l _{OL}	Low-level output current			12			24	mA
T _A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555	7507.04	TEST CONDITIONS					4ALS10	34	
PARAMETER	TEST CO	DNDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2			
V/		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		٧
VOH	V _{CC} = 4.5 V	$I_{OH} = -12 \text{ mA}$	2						V
		$I_{OH} = -15 \text{ mA}$				2			
\/	V 45V	$I_{OL} = 12 \text{ mA}$		0.25	0.4				V
VOL	V _{CC} = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V
lį	$V_{CC} = 5.5 V,$	V _I = 7 V			0.1			0.1	mA
lН	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ
IIL	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
I _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
Іссн	V _{CC} = 5.5 V,	V _I = 4.5 V		3	6		3	6	mA
ICCL	$V_{CC} = 5.5 \text{ V},$	V _I = 0		8	14		8	14	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SN54ALS1034, SN54AS1034A, SN74ALS1034, SN74AS1034A HEX DRIVERS

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L R _L T _A	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = \text{MIN to MAX}^{\dagger}$ SN54ALS1034 SN74ALS1034					
			MIN	MAX	MIN	MAX			
t _{PLH}	٨	V	1	11	1	8	20		
^t PHL	А	1	1	13	1	8	ns		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}		 7 V
Input voltage, V _I		 7 V
Operating free-air temperature range, T _A :	SN54AS1034A	 -55°C to 125°C
	SN74AS1034A	 0°C to 70°C
Storage temperature range		 -65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions§

		SN	54AS103	4A	SN7	74AS103	4A	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			8.0			0.8	V
IOH	High-level output current			-40			-48	mA
lOL	Low-level output current			40			48	mA
TA	Operating free-air temperature	-55		125	0		70	°C

[§] These high sink- or source-current devices are not recommended for use above 40 MHz.

SN54ALS1034, SN54AS1034A, SN74ALS1034, SN74AS1034A HEX DRIVERS

SDAS053B - APRIL 1982 - REVISED JANUARY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS					4AS103	4A	
PARAMETER	TEST Co	ONDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT
VIK	$V_{CC} = 4.5 V,$	I _I = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	VCC -2	2		V _{CC} -2			
V		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	V _{CC} = 4.5 V	$I_{OH} = -40 \text{ mA}$	2						V
		$I_{OH} = -48 \text{ mA}$				2			
.,	V 45.V	$I_{OL} = 40 \text{ mA}$		0.25	0.5				.,
VOL	V _{CC} = 4.5 V	$I_{OL} = 48 \text{ mA}$					0.35	0.5	V
lj	$V_{CC} = 5.5 V$,	V _I = 7 V			0.1			0.1	mA
lіН	$V_{CC} = 5.5 V$,	V _I = 2.7 V			20			20	μΑ
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.5			-0.5	mA
I _O ‡	V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-200	-50		-200	mA
ICCH	V _{CC} = 5.5 V,	V _I = 4.5 V		9	15		9	15	mA
ICCL	V _{CC} = 5.5 V,	V _I = 0		21	35		21	35	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

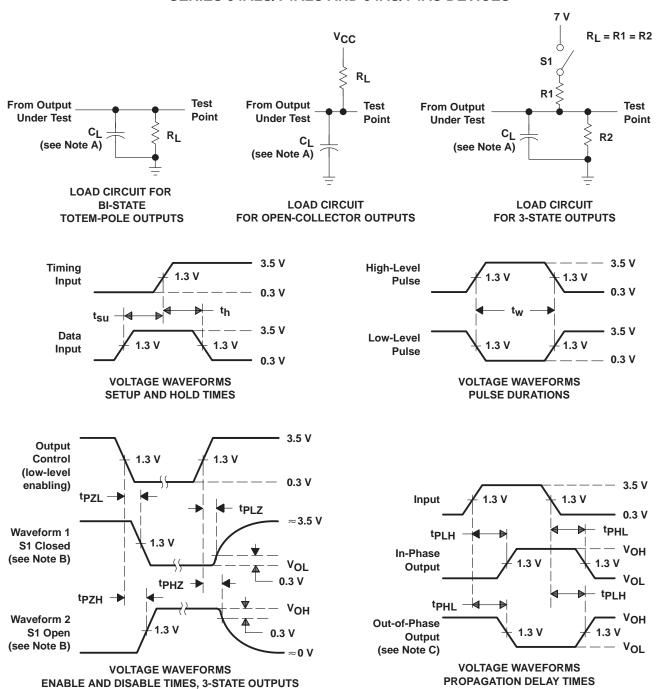
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C , C _L R _L T _A		UNIT		
			SN54AS	1034A	SN74AS	1034A	
			MIN	MAX	MIN	MAX	
tPLH	^	V	1	6.5	1	6	20
t _{PHL}	A	1	1	6.5	1	6	ns

 $[\]S$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_I includes probe and jig capacitance.

- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: $PRR \le 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8873101CA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8873101CA SNJ54AS1034AJ	Samples
84031012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84031012A SNJ54ALS 1034FK	Samples
8403101CA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8403101CA SNJ54ALS1034J	Samples
JM38510/38411BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 38411BCA	Samples
M38510/38411BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 38411BCA	Samples
SN54ALS1034J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS1034J	Samples
SN54AS1034AJ	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54AS1034AJ	Samples
SN74ALS1034D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1034	Samples
SN74ALS1034DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1034	Samples
SN74ALS1034DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1034	Samples
SN74ALS1034N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS1034N	Samples
SN74ALS1034NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1034	Samples
SN74AS1034AD	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS1034A	Samples
SN74AS1034ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS1034A	Samples
SN74AS1034AN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS1034AN	Samples
SNJ54ALS1034FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84031012A SNJ54ALS 1034FK	Samples
SNJ54ALS1034J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8403101CA SNJ54ALS1034J	Samples

PACKAGE OPTION ADDENDUM

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Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54AS1034AJ	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8873101CA SNJ54AS1034AJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS1034, SN54AS1034A, SN74ALS1034, SN74AS1034A:

PACKAGE OPTION ADDENDUM

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• Catalog : SN74ALS1034, SN74AS1034A

• Military : SN54ALS1034, SN54AS1034A

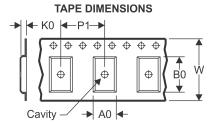
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

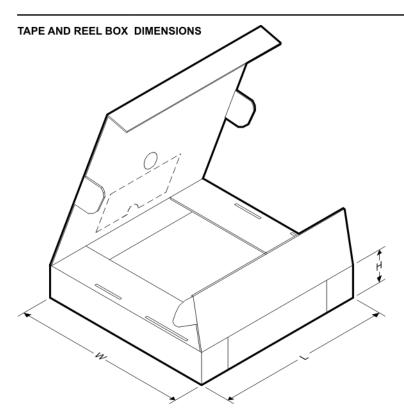
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS1034DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74ALS1034NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74AS1034ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

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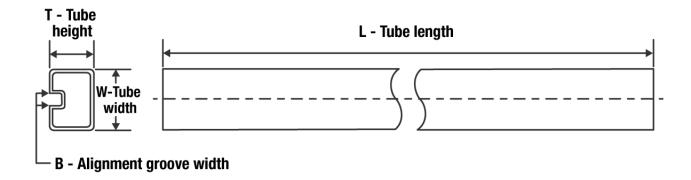


*All dimensions are nominal

7 til dillionorio di o momina							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS1034DR	SOIC	D	14	2500	853.0	449.0	35.0
SN74ALS1034NSR	SO	NS	14	2000	853.0	449.0	35.0
SN74AS1034ADR	SOIC	D	14	2500	853.0	449.0	35.0

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
84031012A	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74ALS1034D	D	SOIC	14	50	506.6	8	3940	4.32
SN74ALS1034DG4	D	SOIC	14	50	506.6	8	3940	4.32
SN74ALS1034N	N	PDIP	14	25	506	13.97	11230	4.32
SN74ALS1034N	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1034AD	D	SOIC	14	50	506.6	8	3940	4.32
SN74AS1034AN	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1034AN	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54ALS1034FK	FK	LCCC	20	1	506.98	12.06	2030	NA

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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